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#### April 2015

## FDB082N15A N-Channel PowerTrench<sup>®</sup> MOSFET 150 V, 117 A, 8.2 mΩ

#### Features

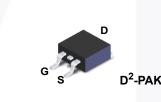
- $R_{DS(on)}$  = 6.7 m $\Omega$  (Typ.) @  $V_{GS}$  = 10 V,  $I_D$  = 75 A
- · Fast Switching Speed
- Low Gate Charge, Q<sub>G</sub> = 64.5 nC (Typ.)
- High Performance Trench Technology for Extremely Low  $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

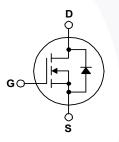
#### Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench<sup>®</sup> process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

#### Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor drives and Uninterruptible Power Supplies
- Micro Solar Inverter





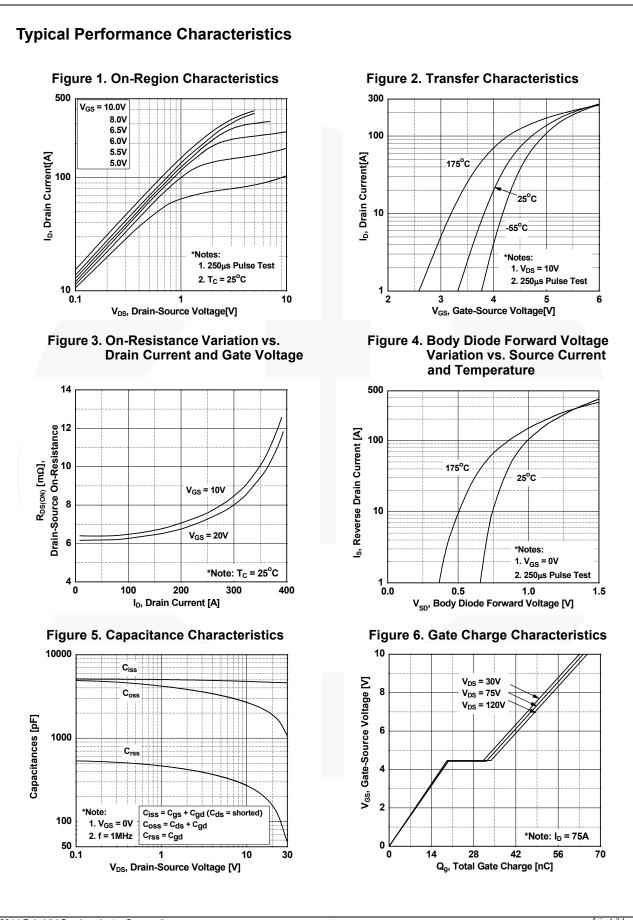
#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

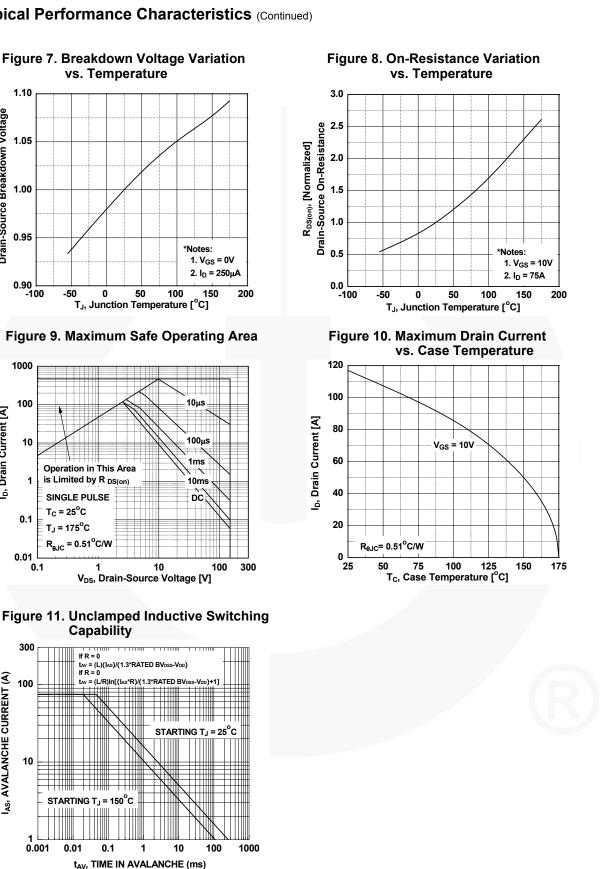
Symbol		FDB082N15A	Unit V		
V <sub>DSS</sub>	Drain to Source Voltage	150			
V <sub>GSS</sub>	Cata ta Sauraa Maltaga	- DC	±20	V	
	Gate to Source Voltage	- AC (f > 1 Hz)	±30	V	
I <sub>D</sub>	Drain Current	- Continuous (T <sub>C</sub> = 25°C, Silicon Limited)	117	A	
	Drain Current	- Continuous (T <sub>C</sub> = 100°C, Silicon Limited)	83		
I <sub>DM</sub>	Drain Current	- Pulsed (Note 1)	468	Α	
E <sub>AS</sub>	Single Pulsed Avalanche Energy	542	mJ		
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6	V/ns	
P <sub>D</sub>	Dower Dissinction	(T <sub>C</sub> = 25°C)	294	W	
	Power Dissipation	- Derate Sbove 25°C	1.96	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Tempera	-55 to +175	°C		
TL	Maximum Lead Temperature for	300	°C		

#### **Thermal Characteristics**

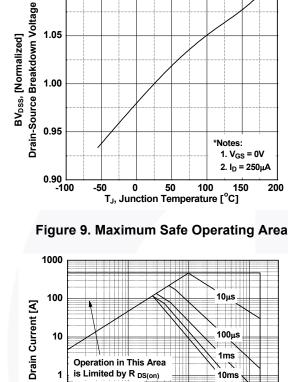
Symbol	Parameter	FDB082N15A	Unit		
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.51	°C/W		
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/W		

	nber	Top Mark	Packag	e Packing Meth	od Reel Siz	e Tap	be Width	Qua	ntity
FDB082N	FDB082N15A FDB082N15A D		D <sup>2</sup> -PAK	Tape and Re	el 330 mn	า 2	24 mm	800 units	
Electrica	l Chara	acteristics T <sub>C</sub> =2	5ºC unless	otherwise noted.					
Symbol		Parameter		Test Cor	nditions	Min.	Тур.	Max.	Uni
Off Charac	toristics						4	r.	
BV <sub>DSS</sub>			tana	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V, T <sub>C</sub> = 25 <sup>o</sup> C			_	-	V
∆BV <sub>DSS</sub>	Drain to Source Breakdown Voltage Breakdown Voltage Temperature		-				-	-	
$/\Delta T_J$	Coefficient		C	$I_D = 250 \ \mu$ A, Referenced to $25^{\circ}$ C			0.08	-	V/ºC
	Zero Gate Voltage Drain Current		.+	$V_{DS}$ = 120 V, $V_{GS}$ = 0 V $V_{DS}$ = 120 V, $T_{C}$ = 150°C			-	1	
DSS			IL .				-	500	μΑ
I <sub>GSS</sub>	Gate to Body Leakage Current			$V_{GS} = \pm 20 V, V_{DS} = 0 V$			-	±100	nA
On Charac	teristics								
V <sub>GS(th)</sub>	Gate Thr	reshold Voltage		$V_{GS} = V_{DS}, I_{D} = 25$	50 μA	2.0	-	4.0	V
R <sub>DS(on)</sub>		ain to Source On Resis	tance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 7$		-	6.7	8.20	mΩ
9FS	Forward Transconductance			$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 75$		-	139	-	S
				50 5			_		
Dynamic C				1			1		
C <sub>iss</sub>		pacitance		V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V,		-	4645	6040	pF
C <sub>oss</sub>		apacitance		f = 1  MHz	50 00		1445	1880	pF
C <sub>rss</sub>		Transfer Capacitance				-	100	-	pF
C <sub>iss</sub>		pacitance		V <sub>DS</sub> = 75 V, V <sub>GS</sub> =	0 V.	-	4570	6040	pF
C <sub>oss</sub>		apacitance		f = 1 MHz	- ,		460	1880	pF
C <sub>rss</sub>		Transfer Capacitance				-	20	-	pF
Q <sub>g(tot)</sub>		te Charge at 10V		V <sub>DS</sub> = 120 V, I <sub>D</sub> =	75 A	-	64.5	84	nC
Q <sub>gs</sub>		Source Gate Charge		$V_{GS} = 10 V$	1070,	-	19.1	-	nC
Q <sub>gs2</sub>		arge Threshold to Plate	au	-		-	8.7	-	nC
Q <sub>gd</sub>		Drain "Miller" Charge		6 4 MUL	(Note	,	13.5	-	nC
ESR	Equivale	nt Series Resistance (G	5-5)	f = 1 MHz			2.5	-	Ω
Switching	Charact	eristics							
t <sub>d(on)</sub>	1	Delay Time				-	22	54	ns
t <sub>r</sub>		Rise Time		$V_{DD} = 75 V, I_D = 75$			58	126	ns
t <sub>d(off)</sub>	Turn-Off	Delay Time		V <sub>GS</sub> = 10 V, R <sub>G</sub> = 4.7 Ω		-	61	132	ns
t <sub>f</sub>	Turn-Off	Fall Time		_	(Note		26	62	ns
		. Characteristics				1	1		
	I	e Characteristics	Diad	E				447	•
S	Maximum Continuous Drain to Source Diode Forward Current Maximum Pulsed Drain to Source Diode Forward Current				-	-	117	A	
SM		Source Diode Forward			= ^	-	-	468	A
V <sub>SD</sub>		Recovery Time	vollage	$V_{GS} = 0 V, I_{SD} = 75 A$ $V_{GS} = 0 V, I_{SD} = 75 A,$ $dI_{F}/dt = 100 A/\mu s$		-	96	1.25	
t <sub>rr</sub> Q <sub>rr</sub>		Recovery Charge				_	268		ns nC
	1.010136	Coovery Charge				-	200		





## Typical Performance Characteristics (Continued)



1.10

1.05

10

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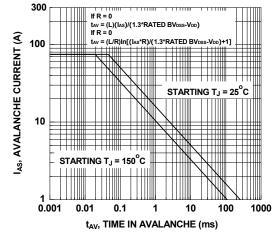
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0.01

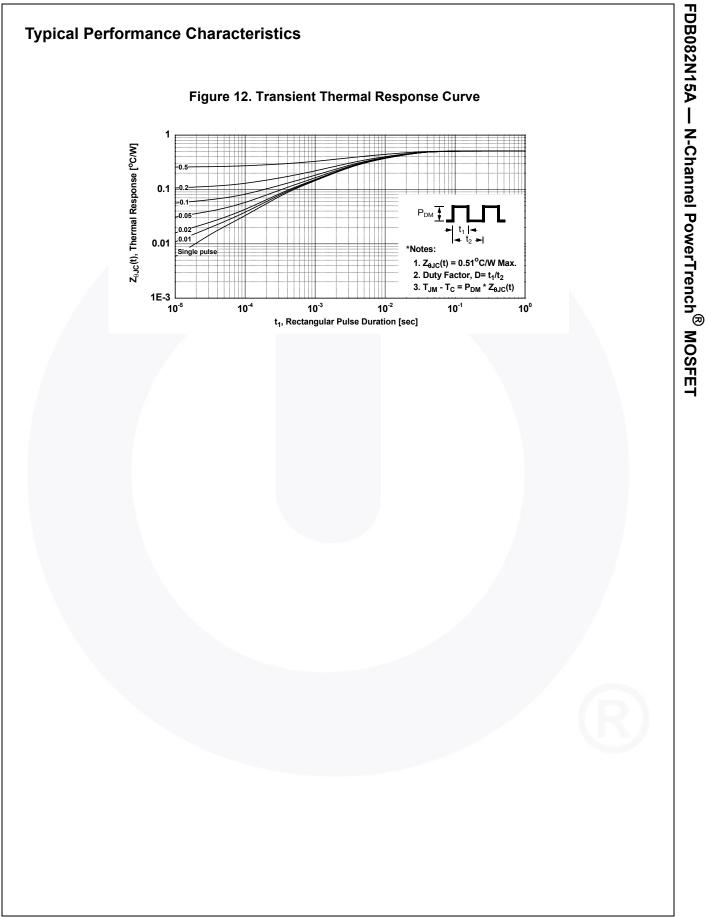
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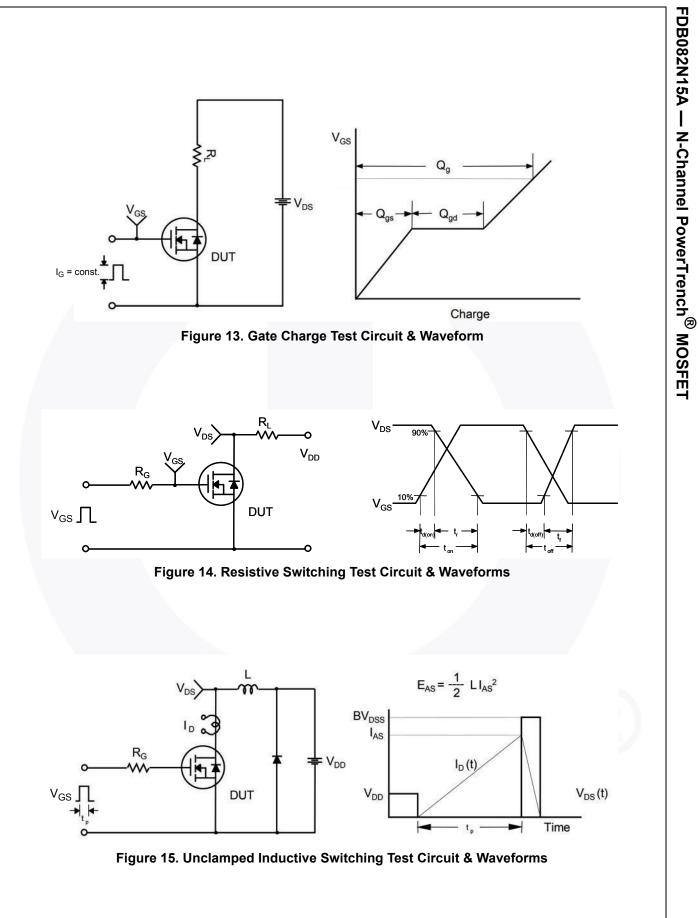
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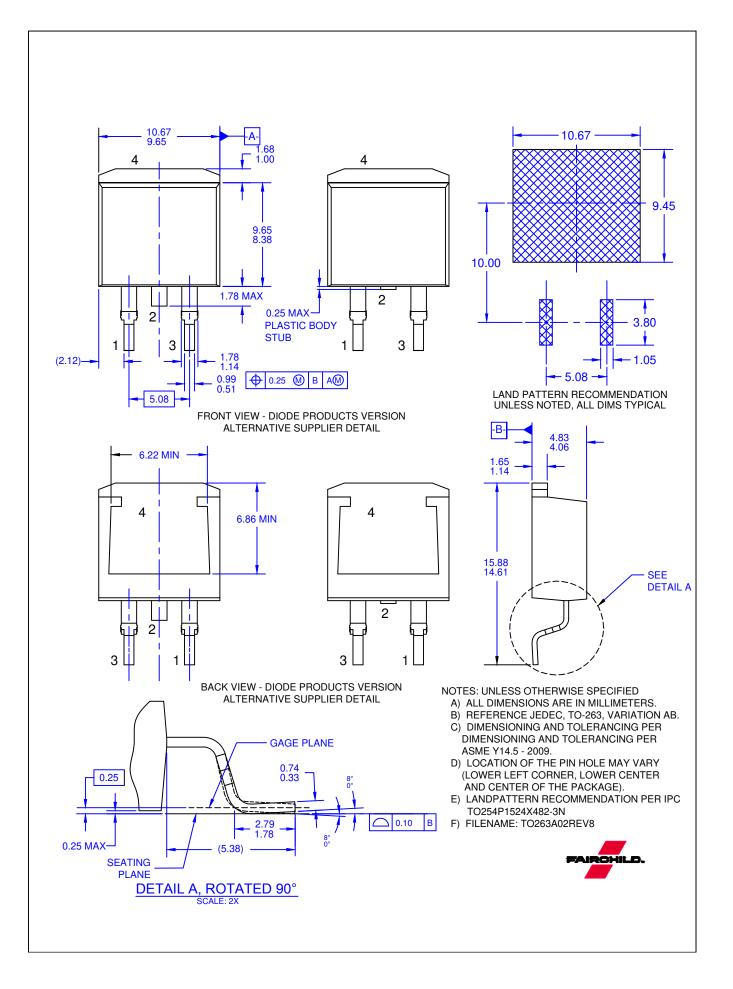
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DUT +  $V_{DS}$ a ۱<sub>SD</sub> م L Driver R<sub>G</sub>, Same Type as DUT L F V<sub>DD</sub>  $\prod V_{GS}$ • dv/dt controlled by R<sub>G</sub> • I<sub>SD</sub> controlled by pulse period Î Gate Pulse Width V<sub>GS</sub> D = Gate Pulse Period 10V (Driver) I<sub>FM</sub>, Body Diode Forward Current I <sub>SD</sub> di/dt (DUT)  $I_{RM}$ Body Diode Reverse Current  $V_{DS}$ (DUT) Body Diode Recovery dv/dt  $V_{SD}$ V<sub>DD</sub> Body Diode Forward Voltage Drop Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

FDB082N15A — N-Channel PowerTrench<sup>®</sup> MOSFET



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